



#### **FAST TRANSIENT 3.5A STEP-DOWN CONVERTER**

## **Description**

The PAM2325 is a 3.5A step-down synchronous converter. The 1.2MHz switching frequency enables the use of small external components. The ultra-small 2mm x 2mm footprint and high efficiency make the PAM2325 an ideal choice for portable applications.

The PAM2325 delivers 3.5A maximum output current while consuming only  $55\mu A$  no load quiescent current. Low R integrated MOSFETs and 100% duty cycle operation make the PAM2325 the ideal choice for high output voltage, high current applications which require a low dropout threshold.

The PAM2325 provides excel lent transient response and output accuracy across the operating range.

The PAM2325 maintains high efficiency throughout the load range.

The PAM2325 automatically optimizes efficiency during light load mode (PSM) and maintains constant frequency and low output ripple during PWM mode.

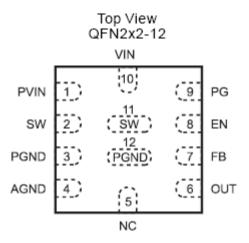
Over-temperature and short circuit protection safeguard the PAM2325 and system components from damage.

The PAM2325 is available in an ultra-small QFN2x2-12 package. The product is rated over a temperature range of -40°C to +85°C.

### **Applications**

- Cellular Phone
- Digital Cameras
- Hard Disk Drives
- MP3 Players
- PDAs and Handheld Computers
- Portable Media Players
- USB Devices
- Wireless Network Cards

## **Pin Assignments**



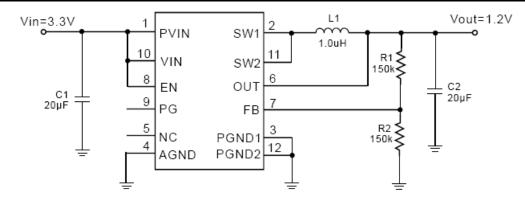
#### **Features**

- 3.5A Maximum Output Current
- Tiny 1.0µH Chip Inductor
- Excellent Transient Response
- Input Voltage: 2.5V to 5.5V
- Adjustable Output Voltage: 1.0V to 4.0V
- High Efficiency with 1.2MHz Switching Frequency
- 55μA No Load Quiescent Current
- 100% Duty Cycle Low-Dropout Operation
- Internal Soft Start
- Power Good Indicator
- Over-Temperature and Current Limit Protection
- Hiccup mode for output short protection
- 1µA Shutdown Current
- -40°C to +85°C Temperature Range
- Available in QFN2x2-12 Package
- RoHS/REACH Compliant





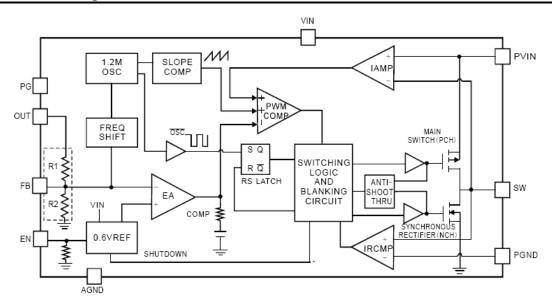
# **Typical Applications Circuit**



# **Pin Descriptions**

Pin Number	Pin Name	Function	
1	PVIN	Supply Voltage to power FETs. PVIN is connected to VIN internally.	
2, 11	SW	Switch Output. Pin 2 and 11 can be connected together.	
3, 12	PGND	Power Ground. Pin 3 and 12 can be connected together.	
4	AGND	Quiet ground for controller circuits	
5	NC	Leave this pin open. Do not connect it to ground.	
6	OUT	Input sense pin for output voltage	
7	FB	Feedback. An external resistor divider from the output to GND, tapped to the FB pin, sets the output voltage.	
8	EN	On/Off Control.	
9	PG	Power Good Indicator. The output of this pin is an open drain with internal pull up resistor to VIN. PG is pulled up to VIN when the FB voltage is within 10% of the regulation level, otherwise it is LOW.	
10	VIN	Supply Voltage to internal control circuitry. VIN is connected to PVIN internally.	

# **Functional Block Diagram**





### **Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

These are stress ratings only and functional operation is not implied. Exposure to absolute maximum ratings for prolonged time periods may affect device reliability. All voltages are with respect to ground.

Parameter	Rating	Unit
Input Voltage	-0.3 to +6.5	V
EN, FB Pin Voltage	-0.3 to V <sub>IN</sub>	V
SW Pin Voltage	-0.3 to (V <sub>IN</sub> +0.3)	V
Junction Temperature	150	°C
Storage Temperature Range	-65 to +150	°C
Soldering Temperature	300, 5sec	°C

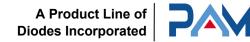
# Recommended Operating Conditions (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Parameter	Rating	Unit
Supply Voltage	2.5 to 5.5	V
Operation Temperature Range	-40 to +85	°C
Junction Temperature Range	-40 to +125	C

# **Thermal Information**

Parameter	Symbol	Package	Max	Unit
Thermal Resistance (Junction to Case)	$\theta_{JC}$	QFN2x2-12	16	°C/W
Thermal Resistance (Junction to Ambient)	$\theta_{JA}$	QFN2x2-12	80	C/VV







**PAM2325** 

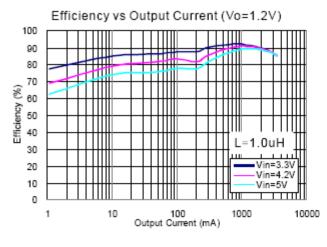
# **Electrical Characteristics**

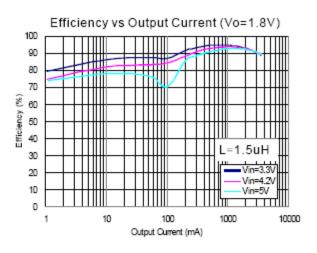
 $(@T_A = +25^{\circ}C, \ V_{IN} = 3.3V, \ V_{OUT} = 1.2V, \ C_{IN} = 20\mu F, \ C_O = 20\mu F, \ L = 1\mu H, \ unless \ otherwise \ specified.)$ 

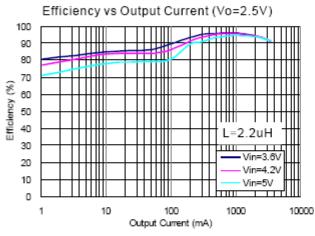
Parameter	Symbol	Test	Conditions	Min	Тур	Max	Units
Input Voltage Range	V <sub>IN</sub>			2.5	3.3	5.5	V
LIV/I O Throughold	.,	V <sub>IN</sub> Rising		2.35	2.5	2.65	V
UVLO Threshold	V <sub>UVLO</sub>	Hysteresis			400	550	mV
Output Voltage Accuracy	Vout			-4.0		+4.0	%
Regulated Feedback Voltage	$V_{FB}$	No Load		0.591	0.60	0.609	V
PMOS Current Limit	I <sub>LIM</sub>				4.8		Α
Output Voltage Line Regulation	LNR	V <sub>IN</sub> = 3.3V to 5.5V			0.5	1	%/V
Output Voltage Load Regulation	LDR	$I_O = 1$ mA to 2A				2	%
Quiescent Current	IQ	No Load			55	100	μΑ
Shutdown Current	I <sub>SD</sub>	V <sub>EN</sub> = 0V				1	μΑ
Oscillator Frequency	fosc			1.0	1.2	1.6	MHz
Drain-Source On-State Resisitance	Б	I = 100mA	P MOSFET		40	70	mΩ
Diain-Source On-State Resisitance	R <sub>DS(ON)</sub>	I <sub>DS</sub> = 100mA	N MOSFET		30	50	mΩ
SW Leakage Current	$I_{LSW}$					1	μΑ
Start-Up Time	ts				250	1000	μs
PSM Threshold	I <sub>TH</sub>	$V_{IN} = 3.3V, V_{O} = 1$	.2V			250	mA
EN Threshold High	$V_{EH}$			1.2			V
EN Threshold Low	V <sub>EL</sub>					0.4	V
EN Input Current	I <sub>EN</sub>	V <sub>EN</sub> = 2V			1.2	4	μA
Over Temperature Protection	OTP				150		°C
OTP Hysteresis	OTH				30		°C
		I <sub>O</sub> = 10mA		75	81		
Effciency	η	I <sub>O</sub> = 500mA to 1A		85	90		
Littleficy		I <sub>O</sub> = 1.5A		85	90		%
		I <sub>O</sub> = 2A		80	89		
Output Ripple	Ripple	I <sub>O</sub> = 10mA		-5		+5	%
Output Ripple		I <sub>O</sub> ≥ 300mA		-2		+2	70
Outrot Transient Dinnle	V <sub>PK-PK</sub>	I <sub>O</sub> = 20mA to 1A		-10		+10	- %
Output Transient Ripple		I <sub>O</sub> = 20mA to 2A		-12		+12	
PG Pin Trigger Delay					90		μs
PG Pin Threshold (relative to V <sub>OUT</sub> )					±10		%
PG Open Drain Impedance (PG = PV <sub>IN</sub> )				250K	500K		Ω
PG Open Drain Impedance (PG = Low)						100	Ω

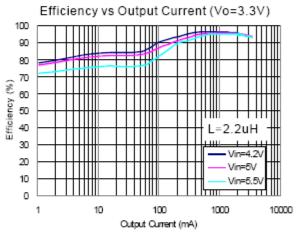


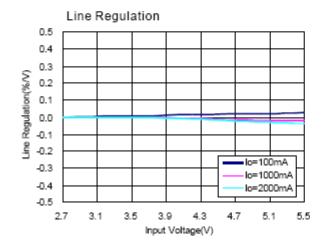
 $\textbf{Typical Performance Characteristics} \ (@T_A = +25^{\circ}C,\ C_{IN} = 20\mu\text{F},\ C_O = 20\mu\text{F},\ V_O = 1.2\text{V},\ unless \ otherwise \ specified.})$ 

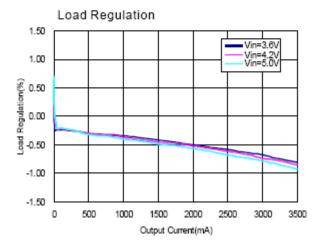






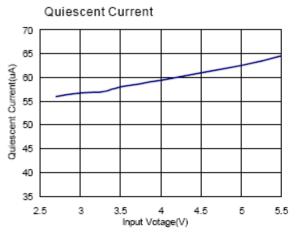


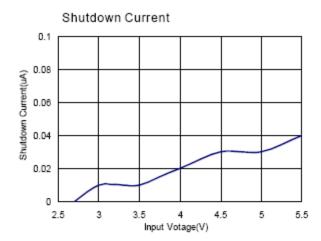


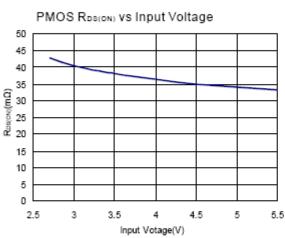


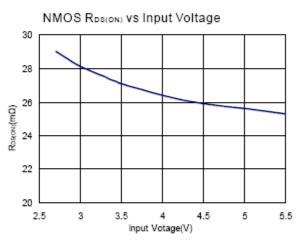


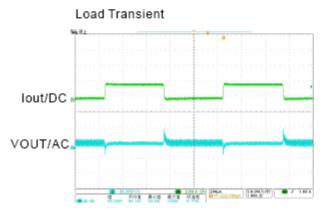
# Typical Performance Characteristics (cont.) (@T<sub>A</sub> = +25°C, C<sub>IN</sub> = 10µF, C<sub>O</sub> = 10µF, V<sub>O</sub> = 1.2V, unless otherwise specified.)

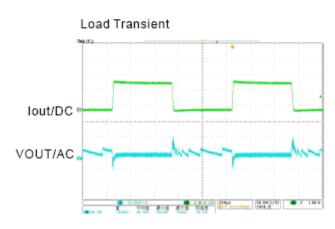












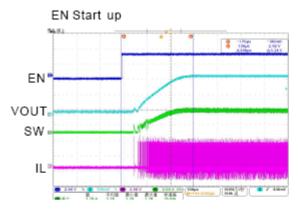
Vin=3.3V, Vo=1.2V, Io=0.2A~2A, f=1kHz

Vin=3.3V, Vo=1.2V, Io=0A~3.5A, f=1kHz



# Typical Performance Characteristics (cont.) (@T<sub>A</sub> = +25°C, C<sub>IN</sub> = 10µF, C<sub>O</sub> = 10µF, V<sub>O</sub> = 1.2V, unless otherwise specified.)

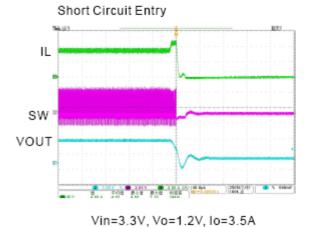
IL



Vin=3.3V, Vo=1.2V, Io=3A



Vin=3.3V, Vo=1.2V, Io=1A



EN Shut Down

EN

SW

B

B

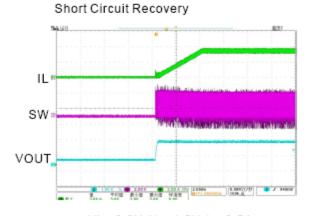
B

SW

B

Vin=3.3V, Vo=1.2V, Io=3A







## **Application Information**

The basic PAM2325 application circuit is shown on Page 1. External component selection is determined by the load requirement, selecting L first and then  $C_{IN}$  and  $C_{OUT}$ .

#### **Inductor Selection**

For most applications, the value of the inductor will fall in the range of  $1\mu$ H to  $3.3\mu$ H. Its value is chosen based on the desired ripple current. Large value inductors lower ripple current and small value inductors result in higher ripple currents. Higher  $V_{IN}$  or  $V_{OUT}$  also increases the ripple current as shown in equation 3.5A reasonable starting point for setting ripple current is  $\Delta I_L = 1.4A$  (40% of 3.5A).

$$\Delta I_{L} = \frac{1}{(f)(L)} V_{OUT} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$
 (1)

The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation. Thus, a 4.2A rated inductor should be enough for most applications (3.5A + 0.7A). For better efficiency, choose a low DC-resistance inductor.

### CIN and COUT Selection

In continuous mode, the source current of the top MOSFET is a square wave of duty cycle V<sub>OUT</sub>/V<sub>IN</sub>. To prevent large voltage transients, a low ESR input capacitor sized for the maximum RMS current must be used. The maximum RMS capacitor current is given by:

$$C_{IN}$$
 required  $I_{RMS} \cong I_{OMAX} \frac{\left[V_{OUT} \left(V_{IN} - V_{OUT}\right)\right]^{1/2}}{V_{IN}}$ 

This formula has a maximum at  $V_{IN} = 2V_{OUT}$ , where  $I_{RMS} = I_{OUT}/2$ . This simple worst -case condition is commonly used for design because even significant deviations do not offer much relief. Note that the capacitor manufacturer's ripple current ratings are often based on 2000 hours of life. This makes it advisable to further derate the capacitor, or choose a capacitor rated at a higher temperature than required. Consult the manufacturer if there is any question.

The selection of Cout is driven by the required effective series resistance (ESR).

Typically, once the ESR requirement for  $C_{OUT}$  has been met, the RMS current rating generally far exceeds the  $I_{RIPPLE}$  (P-P) requirement. The output ripple  $\Delta V_{OUT}$  is determined by:

$$\Delta V_{OUT} \approx \Delta I_{I} \left( ESR + 1/8 fC_{OUT} \right)$$

Where f = operating frequency,  $C_{OUT}$  =output capacitance and  $\Delta I_L$  = ripple current in the inductor. For a fixed output voltage, the output ripple is highest at maximum input voltage since  $\Delta I_L$  increases with input voltage.

### **Using Ceramic Input and Output Capacitors**

Higher values, lower cost ceramic capacitors are now becoming available in smaller case sizes. Their high ripple current, high voltage rating and low ESR make them ideal for switching regulator applications. Using ceramic capacitors can achieve very low output ripple and small circuit size.

When choosing the input and output ceramic capacitors, choose the X5R or X7R dielectric formulations. These dielectrics have the best temperature and voltage characteristics of all the ceramics for a given value and size.

#### **Thermal Consideration**

Thermal protection limits power dissipation in the PAM2325. When the junction temperature exceeds +150°C, the OTP (Over Temperature Protection) starts the thermal shutdown and turns the pass transistor off. The pass transistor resumes operation after the junction temperature drops below 120°C.

For continuous operation, the junction temperature should be maintained below 125°C. The power dissipation is defined as:

$$P_D = I_O{}^2 \, \frac{V_O \, R_{DS(ON)H} + \left(V_{IN} - V_O\right) R_{DS(ON)L}}{V_{IN}} + \left(t_{SW} \, F_S \, I_O + I_Q\right) V_{IN}$$

IQ is the step-down converter quiescent current. The term tsw is used to estimate the full load step-down converter switching losses.

For the condition where the step-down converter is in dropout at 100% duty cycle, the total device dissipation reduces to:

$$P_D = I_0^2 R_{DS(ON)H} + I_Q V_{IN}$$



## **Application Information (cont.)**

#### Thermal Consideration (cont.)

Since R<sub>DS(ON)</sub>, quiescent current, and switching losses all vary with input voltage, the total losses should be investigated over the complete input voltage range. The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surrounding airflow and temperature difference between junction and ambient. The maximum power dissipation can be calculated by the following formula:

$$P_D = \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$

Where  $T_{J(MAX)}$  is the maximum allowable junction temperature 125°C.T is the ambient temperature and  $\theta_{JA}$  is the thermal resistance from the junction to the ambient. Based on the standard JEDEC for a two layer thermal test board, the thermal resistance  $\theta_{JA}$  of QFN2X2-12 80°C/W respectively. The maximum power dissipation at  $T_A$  = +25°C can be calculated by following formula:

$$P_D = (125^{\circ}C - 25^{\circ}C) / 80^{\circ}C/W = 1.25W$$

#### **Setting the Output Voltage**

The internal reference is 0.6V (Typical). The output voltage is calculated as below:

The output voltage is given by Table 1.

$$V_O = 0.6x \Biggl(1 + \frac{R1}{R2} \Biggr)$$

Table 1: Resistor selection for output voltage setting.

V <sub>o</sub>	R1	R2
1.2V	150k	150k
1.5V	150k	100k
1.8V	300k	150k
2.5V	380k	120k
3.3V	680k	150k

#### Pulse Skipping Mode (PSM) Description

When load current decreases, the peak switch current in Power-PMOS will be lower than skip current threshold and the device will enter into Pulse Skipping Mode.

In this mode, the device has two states, working state and idle state. First, the device enters into working state control led by internal error amplifier. When the feedback voltage gets higher than internal reference voltage, the device will enter into low I idle state with most of internal blocks disabled. The output voltage will be reduced by loading or leakage current. When the feedback voltage gets lower than the internal reference voltage, the convertor will start a working state again.

### 100% Duty Cycle Operation

As the input voltage approaches the output voltage, the converter turns the P-Channel transistor continuously on. In this mode the output voltage is equal to the input voltage minus the voltage drop across the P-Channel transistor:

$$V_{OUT} = V_{IN} - I_{LOAD} (R_{DSON} + R_L)$$

where  $R_{DS(ON)}$  = P-Channel switch ON resistance,  $I_{LOAD}$  = Output current,  $R_L$  = Inductor DC resistance.

### **UVLO and Soft-Start**

The reference and the circuit remain reset until the  $V_{IN}$  crosses its UVLO threshold. The PAM2325 has an internal soft-start circuit that limits the in-rush current during start-up.

This prevents possible voltage drops of the input voltage and eliminates the output voltage overshoot.

#### **Hiccup Mode Short Circuit Control**

When the converter output is shorted or the device is overloaded,each high-side MOSFET current- limit event turns off the high-side MOSFET and turns on the low-side MOSFET. An internal counter is used to count the each current-limit event. The counter is reset after consecutive high-side MOSFETs turn on without reaching current limit. If the current- limit condition persists, the counter fills up. The control logic then stops both high-side and lowside MOSFETs and waits for a hiccup period, before attemping a new soft-start sequence. The counter bit is decided by  $V_{FB}$  voltage. If  $V_{FB} \le 0.2$ , the counter is 3-bit counter; if  $V_{FB} > 0.2$  the counter is 6-bit counter. The typical hicuup made duty cycle is 1.7%. The hicuup mode is disable during soft-start time.

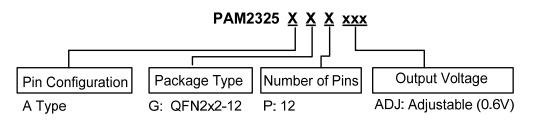


## **Application Information (cont.)**

### **Thermal Shutdown**

When the die temperature exceeds +150°C, a reset occurs and the reset remains until the temperature decrease to +120°C, at which time the circuit can be restarted.

## **Ordering Information**



Part Number Output Voltage		Part Type	Standard Package	
PAM2325AGPADJ CLVXYW		QFN2x2-12	3000 Units/Tape & Reel	

# **Marking Information**

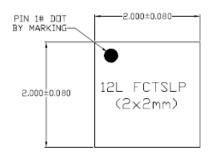
CLV XYW CL: Product Code of PAM2325 V: Output Voltage X: Internal Code

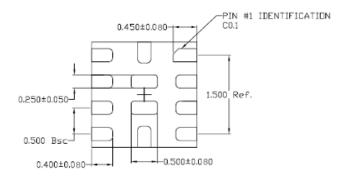
Y: Year W: Week



# Package Outline Dimensions (All dimensions in mm.)

### QFN2x2-12





TOP VIEW

BOTTOM VIEW

### NOTE:

1). ' A ' DIMENSION AS BELOW TABLE

		TSLP
	MAX.	0.800
ΙΑ	N□M.	0.750
	MIN.	0.700







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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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